

FEATURES

- Circular Active Area
- Ideal for EUV Detection
- 100% Internal Quantum Efficiency
- High Speed
- Grid lines 5 microns, Pitch 100 microns
- Superior Radiation Hardness
- High Photon Flux Robustness
- TO-8 package
- Protective Cover Plate³

Electro-Optical Characteristics at 25 °C

Parameters	Test Conditions	Min	Тур	Max	Units
Active Area	Ф5.01 mm		20		mm ²
Responsivity	(see graph on next page)				A/W
Reverse Breakdown Voltage, V_R	I _R = 1 μA	160			Volts
Capacitance, C	V _R = 0 V		200	800	pF
Rise Time	R _L = 50 Ω, V _R = 150 V			3.5	nsec
Dark Current	V _R = 150 V			100	nA

Thermal Parameters

Storage and Operating Temperature Range	Units		
Ambient ¹	-10 ° to 40 °C		
Nitrogen or Vacuum	-20 °C to 80 °C		
Lead Soldering Temperature ²	260 °C		

¹ Temperatures exceeding these parameters may create oxide growth on the active area. Over time responsivity to low energy radiation and wavelengths below 150 nm will be compromised.

 2 0.080" from case for 10 seconds.

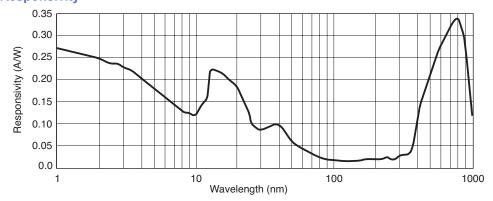
³ Shipped with temporary cover to protect the photodiode array and wire bonds.

Review the Application Note, "Handling Precautions for AXUV, SXUV, and UVG Detectors", prior to removing cover.



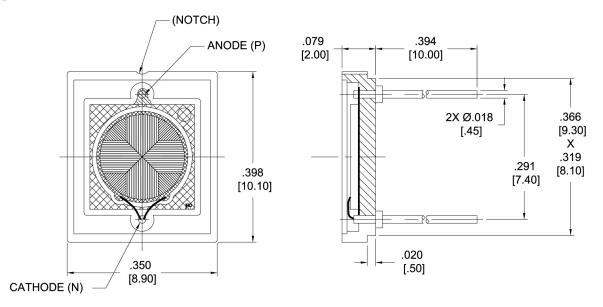


Typical Photon Responsivity



Photodiode Φ5 mm

Package Information



Dimensions are in inch [metric] units.

Ordering Information

ODD-SXU-004

High Speed EUV Photodetector in TO8 Package Shipped with Protective Cover

Specifications are subject to change without prior notice.